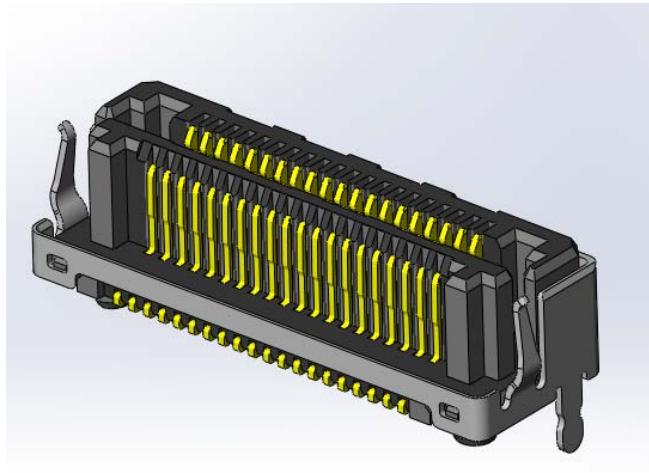
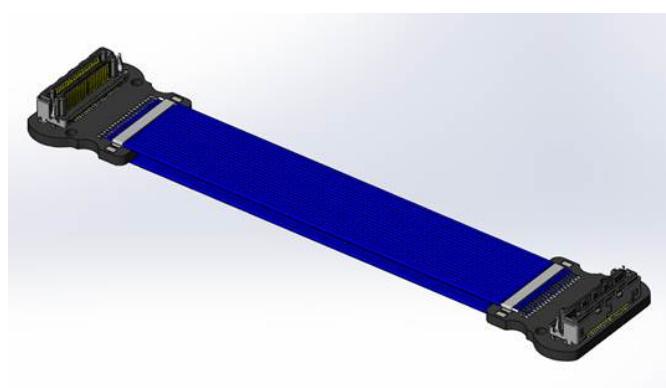




Project Number: Design Qualification Test Report	Tracking Code: 317456_Report_Rev_5
Requested by: Liam Parkes	Date: 9/26/2016
Part #: HLCR-20-06.00-TR-TR-1/LSHM-120-L2.5-L-DV-S	Tech: Troy Cook
Part description: HLCR/LSHM	Qty to test: 65
Test Start: 05/14/2014	Test Completed: 06/04/2014



DESIGN QUALIFICATION TEST REPORT

HLCR/LSHM
HLCR-20-06.00-TR-TR-1/LSHM-120-L2.5-L-DV-S

Tracking Code: 317456 Report Rev 5	Part #: HLCD-20-06.00-TR-TR-1/LSHM-120-L2.5-L-DV-S
Part description: HLCD/LSHM	

REVISION HISTORY

DATA	REV.NUM.	DESCRIPTION	ENG
06/12/2014	1	Initial Issue	PC
06/18/2015	2	Update the IR_DWV test data	PC
11/24/2015	3	Add the CCC test data	PC
12/01/2015	4	Remove the S&V test data	PC
9/26/2016	5	Add the S&V test data	KH

CERTIFICATION

All instruments and measuring equipment were calibrated to National Institute for Standards and Technology (NIST) traceable standards according to ISO 10012-1 and ANSI/NCSL 2540-1, as applicable.

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SCOPE

To perform the following tests: Design Qualification test. Please see test plan.

APPLICABLE DOCUMENTS

Standards: EIA Publication 364

TEST SAMPLES AND PREPARATION

- 1) All materials were manufactured in accordance with the applicable product specification.
- 2) All test samples were identified and encoded to maintain traceability throughout the test sequences.
- 3) After soldering, the parts to be used for DWV/IR testing were cleaned according to TLWI-0001.
- 4) Either an automated cleaning procedure or an ultrasonic cleaning procedure may be used.
- 5) The automated procedure is used with aqueous compatible soldering materials.
- 6) Parts not intended for testing DWV/IR are visually inspected and cleaned if necessary.
- 7) Any additional preparation will be noted in the individual test sequences.
- 8) Solder Information: Lead free
- 9) Samtec Test PCBs used: PCB-106162-TST/PCB-106163-TST/PCB-107373-TST

FLOWCHARTS

IR/DWV

Pin-to-Pin

<u>Group 1</u>	<u>Group 2</u>	<u>Group 3</u>	<u>Group 4</u>
HLCD-20-06.00-TR-TR-1 LSHM-120-L2.5-L-DV-S 2 Assemblies	HLCD-20-06.00-TR-TR-1 2 Assemblies	LSHM-120-L2.5-L-DV-S 2 Assemblies	HLCD-20-06.00-TR-TR-1 LSHM-120-L2.5-L-DV-S 2 Assemblies
Step	Description	Step	Description
1. DWV Breakdown	1. DWV Breakdown	1. DWV Breakdown	1. IR 2. DWV at Test Voltage 3. Thermal Shock 4. IR 5. DWV at Test Voltage 6. Humidity 7. IR 8. DWV at Test Voltage

Pin-to-Ground

<u>Group 5</u>	<u>Group 6</u>	<u>Group 7</u>	<u>Group 8</u>
HLCD-20-06.00-TR-TR-1	HLCD-20-06.00-TR-TR-1	LSHM-120-L2.5-L-DV-S	HLCD-20-06.00-TR-TR-1
LSHM-120-L2.5-L-DV-S		2 Assemblies	LSHM-120-L2.5-L-DV-S
2 Assemblies	2 Assemblies	2 Assemblies	2 Assemblies
Step	Description	Step	Description
1.	DWV Breakdown	1.	DWV Breakdown
Step	Description	Step	Description
1.	IR	1.	IR
2.	DWV at Test Voltage	2.	DWV at Test Voltage
3.	Thermal Shock	3.	Thermal Shock
4.	IR	4.	IR
5.	DWV at Test Voltage	5.	DWV at Test Voltage
6.	Humidity	6.	Humidity
7.	IR	7.	IR
8.	DWV at Test Voltage	8.	DWV at Test Voltage

(1) DWV at Test Voltage = EIA-364-20
Test Condition = 1 (Sea Level)
DWV test voltage is equal to 75% of the lowest breakdown voltage
Test voltage applied for 60 seconds

(2) DWV Breakdown = EIA-364-20
Test Condition = 1 (Sea Level)
DWV test voltage is equal to 75% of the lowest breakdown voltage
Test voltage applied for 60 seconds

(3) Humidity = EIA-364-31
Test Condition = B (240 Hours)
Test Method = III (+25°C to +65°C @ 90% RH to 98% RH)
Test Exceptions: ambient pre-condition and delete steps 7a and 7b

(4) IR = EIA-364-21

(5) Thermal Shock = EIA-364-32
Exposure Time at Temperature Extremes = 1/2 Hour
Method A, Test Condition = I (-55°C to +85°C)
Test Duration = A-3 (100 Cycles)

FLOWCHARTS Continued

Current Carrying Capacity

Group 1
 HLCD-50-12.00-TR-TH-4
 LSHM-150-02.5-L-DV-A-S-K-TR
 2 Pins Powered
 Signal

Step **Description**
 1. CCC (1)
 Rows = 2
 Number of Positions = 1

Group 2
 HLCD-50-12.00-TR-TH-4
 LSHM-150-02.5-L-DV-A-S-K-TR
 4 Pins Powered
 Signal

Step **Description**
 1. CCC (1)
 Rows = 2
 Number of Positions = 2

Group 3
 HLCD-50-12.00-TR-TH-4
 LSHM-150-02.5-L-DV-A-S-K-TR
 6 Pins Powered
 Signal

Step **Description**
 1. CCC (1)
 Rows = 2
 Number of Positions = 3

Group 4
 HLCD-50-12.00-TR-TH-4
 LSHM-150-02.5-L-DV-A-S-K-TR
 8 Pins Powered
 Signal

Step **Description**
 1. CCC (1)
 Rows = 2
 Number of Positions = 4

Group 5
 HLCD-50-12.00-TR-TH-4
 LSHM-150-02.5-L-DV-A-S-K-TR
 100 Pins Powered
 Signal

Step **Description**
 1. CCC (1)
 Rows = 2
 Number of Positions = 50

(1) CCC = EIA-364-70

Method 2, Temperature Rise Versus Current Curve

(TIN PLATING) - Tabulate calculated current at RT, 65°C, 75°C and 95°C after derating 20% and based on 105°C

(GOLD PLATING) - Tabulate calculated current at RT, 85°C, 95°C and 115°C after derating 20% and based on 125°C

FLOWCHARTS Continued**Mechanical Shock/Random Vibration/LLCR****Group 1**

HLCD-50-12.00-TRS-TRS-2

LSHM-150-02.5-L-DV-A-S-K-TR

8 Assemblies

Step Description

1. LLCR ⁽¹⁾
2. Mechanical Shock ⁽²⁾
3. Random Vibration ⁽³⁾
4. LLCR ⁽¹⁾
Max Delta = 15 mOhm

⁽¹⁾ LLCR = EIA-364-23

Open Circuit Voltage = 20 mV Max

Test Current = 100 mA Max

⁽²⁾ Mechanical Shock = EIA-364-27

Test Condition = C (100 G Peak, 6 milliseconds, Half Sine)

Number of Shocks = 3 Per Direction, Per Axis, 18 Total

⁽³⁾ Random Vibration = EIA-364-28

Condition = VB (7.56 gRMS Average, 2 Hours/Axis)

Mechanical Shock/Random Vibration/Event Detection**Group 1**

HLCD-50-12.00-TRS-TRS-2

LSHM-150-02.5-L-DV-A-S-K-TR

60 Points

Step Description

1. Nanosecond Event Detection
(Mechanical Shock) ⁽¹⁾
2. Nanosecond Event Detection
(Random Vibration) ⁽²⁾

⁽¹⁾ Nanosecond Event Detection (Mechanical Shock)

Use EIA-364-87 for Nanosecond Event Detection:

Test Condition = F (50 nanoseconds at 10 ohms)

Use EIA-364-27 for Mechanical Shock:

Test Condition = C (100 G Peak, 6 milliseconds, Half Sine)

Number of Shocks = 3 Per Direction, Per Axis, 18 Total

⁽²⁾ Nanosecond Event Detection (Random Vibration)

Use EIA-364-87 for Nanosecond Event Detection:

Test Condition = F (50 nanoseconds at 10 ohms)

Use EIA-364-28 for Random Vibration:

Condition = VB (7.56 gRMS Average, 2 Hours/Axis)

FLOWCHARTS Continued

Cable Pull

Group 1
 HLCD-20-12.00-TR-TR-1
 LSHM-120-L2.5-L-DV-S
 5 Assemblies
 0 Degrees

Step **Description**
 1. Cable Pull ⁽¹⁾

Group 2
 HLCD-20-12.00-TR-TR-1
 LSHM-120-L2.5-L-DV-S
 5 Assemblies
 90 Degrees

Step **Description**
 1. Cable Pull ⁽¹⁾

(1) Cable Pull = EIA-364-38
 Measure and Record Force Required to Failure
 Failure = Discontinuity >1 microsecond at 10 ohms

Cable Flex

Group 1
 HLCD-20-12.00-TR-TR-1
 LSHM-120-L2.5-L-DV-S
 8 Assemblies
 Flat Cable

Step **Description**
 1. IR ⁽³⁾
 2. DWV at Test Voltage ⁽²⁾
 3. Cable Flex ⁽¹⁾
 4. Visual Inspection
 5. IR ⁽³⁾
 6. DWV at Test Voltage ⁽²⁾

(1) Cable Flex = EIA-364-41
 Circular Jacket Cable - to be tested 90° each direction (180° total)
 Flat Cable - to be tested 70° each direction (140° total)
 Monitor continuity during flex testing
 Failure = Discontinuity >1 microsecond at 10 ohms

(2) DWV at Test Voltage = EIA-364-20
 Test Condition = 1 (Sea Level)
 DWV test voltage is equal to 75% of the lowest breakdown voltage
 Test voltage applied for 60 seconds

(3) IR = EIA-364-21
 Test Condition = 500 Vdc, 2 Minutes Max

ATTRIBUTE DEFINITIONS

The following is a brief, simplified description of attributes.

THERMAL SHOCK:

- 1) EIA-364-32, *Thermal Shock (Temperature Cycling) Test Procedure for Electrical Connectors*.
- 2) Test Condition 1: -55°C to +85°C
- 3) Test Time: ½ hour dwell at each temperature extreme
- 4) Number of Cycles: 100
- 5) All test samples are pre-conditioned at ambient.
- 6) All test samples are exposed to environmental stressing in the mated condition.

HUMIDITY:

- 1) Reference document: EIA-364-31, *Humidity Test Procedure for Electrical Connectors*.
- 2) Test Condition B, 240 Hours.
- 3) Method III, +25° C to + 65° C, 90% to 98% Relative Humidity excluding sub-cycles 7a and 7b.
- 4) All samples are pre-conditioned at ambient.
- 5) All test samples are exposed to environmental stressing in the mated condition.

MECHANICAL SHOCK (Specified Pulse):

- 1) Reference document: EIA-364-27, *Mechanical Shock Test Procedure for Electrical Connectors*
- 2) Test Condition C
- 3) Peak Value: 100 G
- 4) Duration: 6 Milliseconds
- 5) Wave Form: Half Sine
- 6) Velocity: 12.3 ft/s
- 7) Number of Shocks: 3 Shocks / Direction, 3 Axis (18 Total)

VIBRATION:

- 1) Reference document: EIA-364-28, *Vibration Test Procedure for Electrical Connectors*
- 2) Test Condition V, Letter B
- 3) Power Spectral Density: 0.04 G² / Hz
- 4) G 'RMS': 7.56
- 5) Frequency: 50 to 2000 Hz
- 6) Duration: 2.0 Hours per axis (3 axis total)

NANOSECOND-EVENT DETECTION:

- 1) Reference document: EIA-364-87, *Nanosecond-Event Detection for Electrical Connectors*
- 2) Prior to test, the samples were characterized to assure the low nanosecond event being monitored will trigger the detector.
- 3) After characterization it was determined the test samples could be monitored for 50 nanosecond events

LLCR:

- 1) EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets*.
- 2) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
- 3) The following guidelines are used to categorize the changes in LLCR as a result from stressing
 - a. <= +5.0 mOhms: ----- Stable
 - b. +5.1 to +10.0 mOhms: ----- Minor
 - c. +10.1 to +30.0 mOhms: ----- Acceptable
 - d. +30.1 to +50.0 mOhms: ----- Marginal
 - e. +50.1 to +2000 mOhms: ----- Unstable
 - f. >+2000 mOhms: ----- Open Failure

ATTRIBUTE DEFINITIONS Continued

The following is a brief, simplified description of attributes.

TEMPERATURE RISE (Current Carrying Capacity, CCC):

- 1) EIA-364-70, *Temperature Rise versus Current Test Procedure for Electrical Connectors and Sockets*.
- 2) When current passes through a contact, the temperature of the contact increases as a result of $I^2 R$ (resistive) heating.
- 3) The number of contacts being investigated plays a significant part in power dissipation and therefore temperature rise.
- 4) The size of the temperature probe can affect the measured temperature.
- 5) Copper traces on PC boards will contribute to temperature rise:
 - a. Self heating (resistive)
 - b. Reduction in heat sink capacity affecting the heated contacts
- 6) A de-rating curve, usually 20%, is calculated.
- 7) Calculated de-rated currents at four temperature points are reported:
 - a. Ambient
 - b. 65°C
 - c. 75°C
 - d. 95°C
- 8) Typically, neighboring contacts (in close proximity to maximize heat build up) are energized.
- 9) The thermocouple (or temperature measuring probe) will be positioned at a location to sense the maximum temperature in the vicinity of the heat generation area.
- 10) A computer program, *TR 803.exe*, ensures accurate stability for data acquisition.
- 11) Hook-up wire cross section is larger than the cross section of any connector leads/PC board traces, jumpers, etc.
- 12) Hook-up wire length is longer than the minimum specified in the referencing standard.

ATTRIBUTE DEFINITIONS Continued

The following is a brief, simplified description of attributes.

INSULATION RESISTANCE (IR):

To determine the resistance of insulation materials to leakage of current through or on the surface of these materials when a DC potential is applied.

- 1) PROCEDURE:
 - a. Reference document: EIA-364-21, *Insulation Resistance Test Procedure for Electrical Connectors*.
 - b. Test Conditions:
 - i. Between Adjacent Contacts or Signal-to-Ground
 - ii. Electrification Time 2.0 minutes
 - iii. Test Voltage (500 VDC) corresponds to calibration settings for measuring resistances.
- 2) MEASUREMENTS:
- 3) When the specified test voltage is applied (VDC), the insulation resistance shall not be less than 1000 megohms.

DIELECTRIC WITHSTANDING VOLTAGE (DWV):

To determine if the sockets can operate at its rated voltage and withstand momentary over potentials due to switching, surges, and other similar phenomenon. Separate samples are used to evaluate the effect of environmental stresses so not to influence the readings from arcing that occurs during the measurement process.

- 1) PROCEDURE:
 - a. Reference document: EIA-364-20, *Withstanding Voltage Test Procedure for Electrical Connectors*.
 - b. Test Conditions:
 - i. Between Adjacent Contacts or Signal-to-Ground
 - ii. Barometric Test Condition 1
 - iii. Rate of Application 500 V/Sec
 - iv. Test Voltage (VAC) until breakdown occurs
- 2) MEASUREMENTS/CALCULATIONS
 - a. The breakdown voltage shall be measured and recorded.
 - b. The dielectric withstand voltage shall be recorded as 75% of the minimum breakdown voltage.
 - c. The working voltage shall be recorded as one-third (1/3) of the dielectric withstand voltage (one-fourth of the breakdown voltage).

ATTRIBUTE DEFINITIONS Continued

The following is a brief, simplified description of attributes.

CONNECTOR PULL:

- 1) Secure cable near center and pull on connector
 - a. At 90°, right angle to cable
 - b. At 0°, in-line with cable

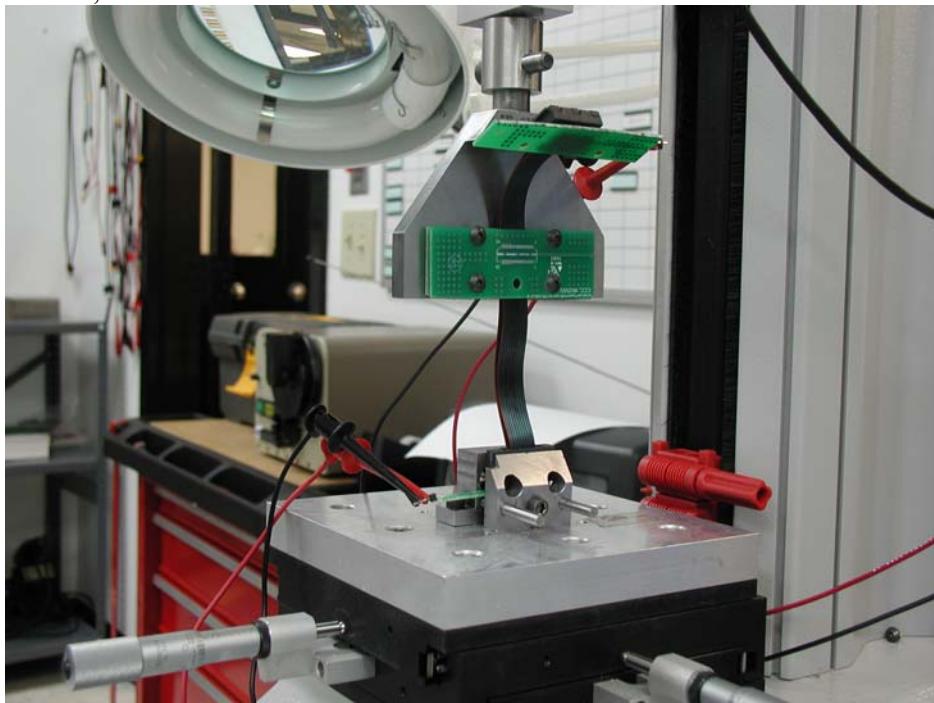


Fig. 1

(Typical set-up, actual part not depicted.)
0° Connector pull, notice the electrical continuity hook-up wires.

ATTRIBUTE DEFINITIONS Continued

The following is a brief, simplified description of attributes.

CABLE DURABILITY:

- 1) Oscillate and monitor electrical continuity for open circuit indication.
 - a. $\pm 70^\circ$ Pendulum Mode, bend up to 500 cycles with 8 oz. load on cable end.



Fig. 2

RESULTS

Temperature Rise, CCC at a 20% de-rating (Signal wire)

- CCC for a 30°C Temperature Rise-----0.9 A per contact with 2 contacts (2x1) powered
- CCC for a 30°C Temperature Rise-----0.7 A per contact with 4 contacts (2x2) powered
- CCC for a 30°C Temperature Rise-----0.6 A per contact with 6 contacts (2x3) powered
- CCC for a 30°C Temperature Rise-----0.5 A per contact with 8 contacts (2x4) powered
- CCC for a 30°C Temperature Rise-----0.3 A per contact with 100 contacts (2x50) powered

LLCR Shock & Vibration (192 LLCR test points)

HLCD-50-24.00-TRS-TRS-2/LSHM-150-02.5-L-DV-A-S-K-TR

- Initial ----- 782.75 mOhms Max
- Shock & Vibration
 - <= +5.0 mOhms ----- 191 Points ----- Stable
 - +5.1 to +10.0 mOhms ----- 1 Points ----- Minor
 - +10.1 to +30.0 mOhms ----- 0 Points ----- Acceptable
 - +30.1 to +50.0 mOhms ----- 0 Points ----- Marginal
 - +50.1 to +2000 mOhms----- 0 Points ----- Unstable
 - >+2000 mOhms ----- 0 Points ----- Open Failure

Mechanical Shock & Random Vibration:

- Shock
 - No Damage----- Pass
 - 50 Nanoseconds----- Pass
- Vibration
 - No Damage----- Pass
 - 50 Nanoseconds----- Pass

Cable Pull force

- 0°
 - Min ----- 9.50 Lbs
 - Max----- 12.00 Lbs
- 90°
 - Min ----- 0.92 Lbs
 - Max----- 1.33 Lbs

RESULTS Continued

Insulation Resistance minimums, IR

Pin to Pin

- Initial
 - Mated ----- 45000 Meg Ω ----- Passed
- Thermal Shock
 - Mated ----- 45000 Meg Ω ----- Passed
- Humidity
 - Mated ----- 45000 Meg Ω ----- Passed

Pin to Ground

- Initial
 - Mated ----- 45000 Meg Ω ----- Passed
- Thermal Shock
 - Mated ----- 45000 Meg Ω ----- Passed
- Humidity
 - Mated ----- 45000 Meg Ω ----- Passed

Dielectric Withstanding Voltage minimums, DWV

• Minimums

- Breakdown Voltage ----- 524 VAC
- Test Voltage ----- 395 VAC
- Working Voltage ----- 130 VAC

Pin to Pin

- Initial DWV ----- Passed
- Thermal DWV ----- Passed
- Humidity DWV ----- Passed

Pin to Ground

- Initial DWV ----- Passed
- Thermal DWV ----- Passed
- Humidity DWV ----- Passed

CABLE FLEX

Insulation Resistance minimums, IR

Pin to Pin

- Initial
 - Mated ----- 37000 Meg Ω ----- Passed
- After flex test
 - Mated ----- 45000 Meg Ω ----- Passed

Pin to Ground

- Initial
 - Mated ----- 45000 Meg Ω ----- Passed
- After flex test
 - Mated ----- 45000 Meg Ω ----- Passed

Dielectric Withstanding Voltage minimums, DWV

• Minimums

- Breakdown Voltage ----- 524 VAC
- Test Voltage ----- 395 VAC
- Working Voltage ----- 130 VAC

Pin to Pin

- Initial DWV ----- Passed
- After Flex DWV ----- Passed

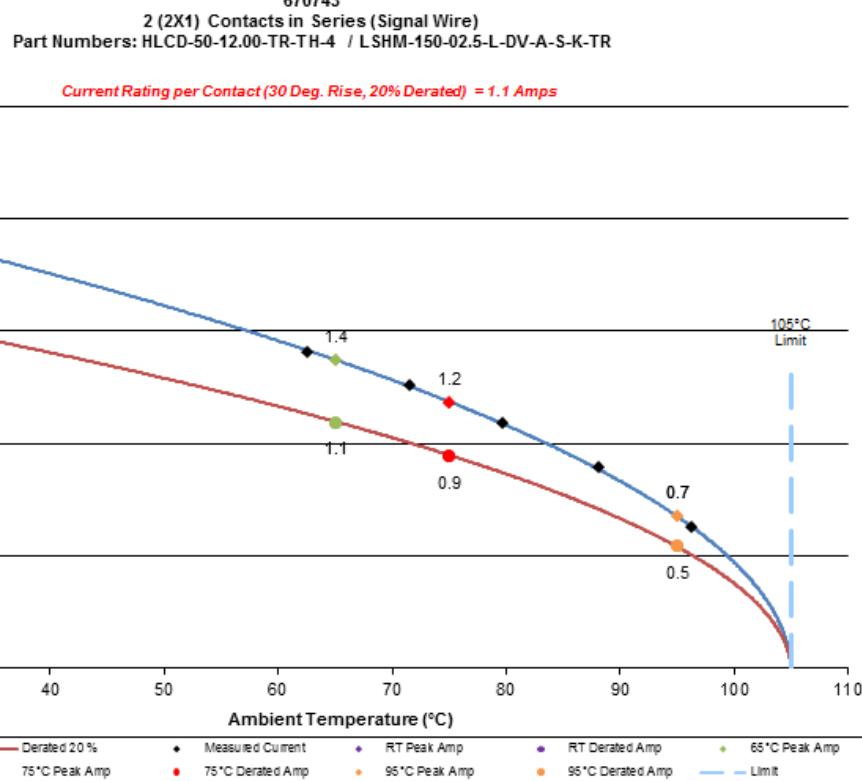
Pin to Ground

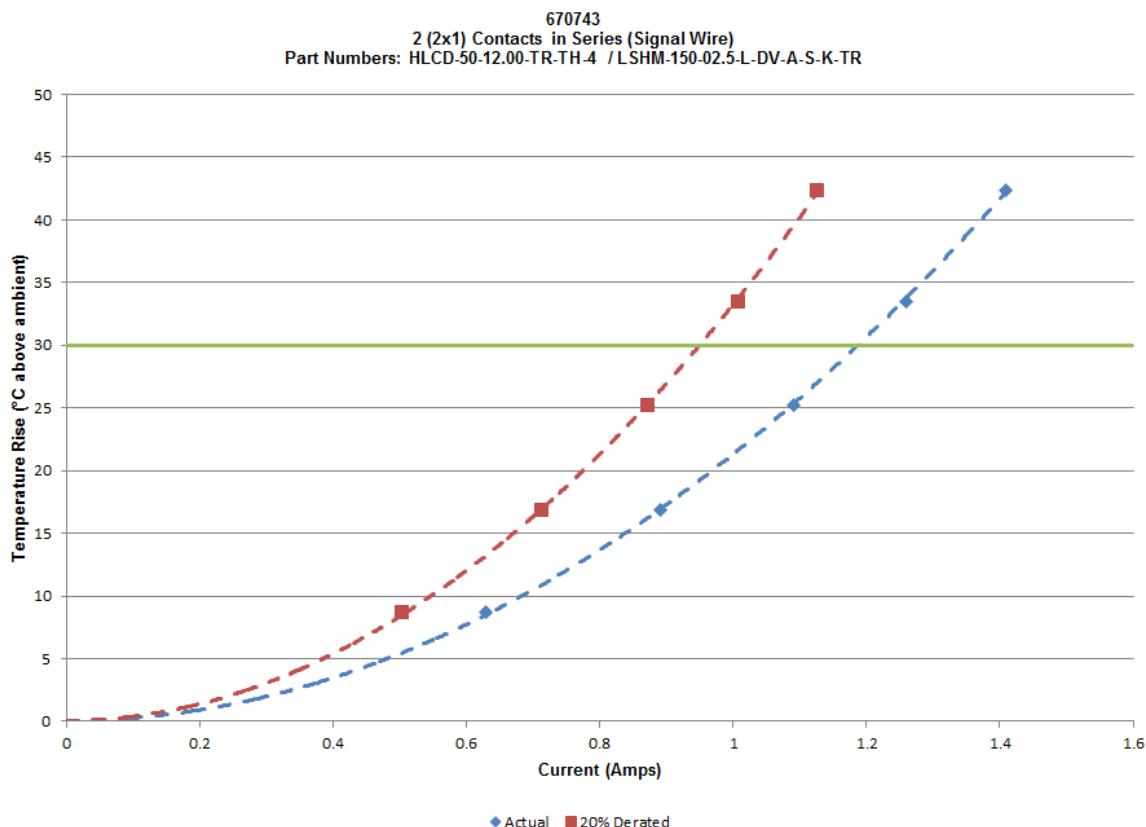
- Initial DWV ----- Passed
- After Flex DWV ----- Passed

DATA SUMMARIES

TEMPERATURE RISE (Current Carrying Capacity, CCC):

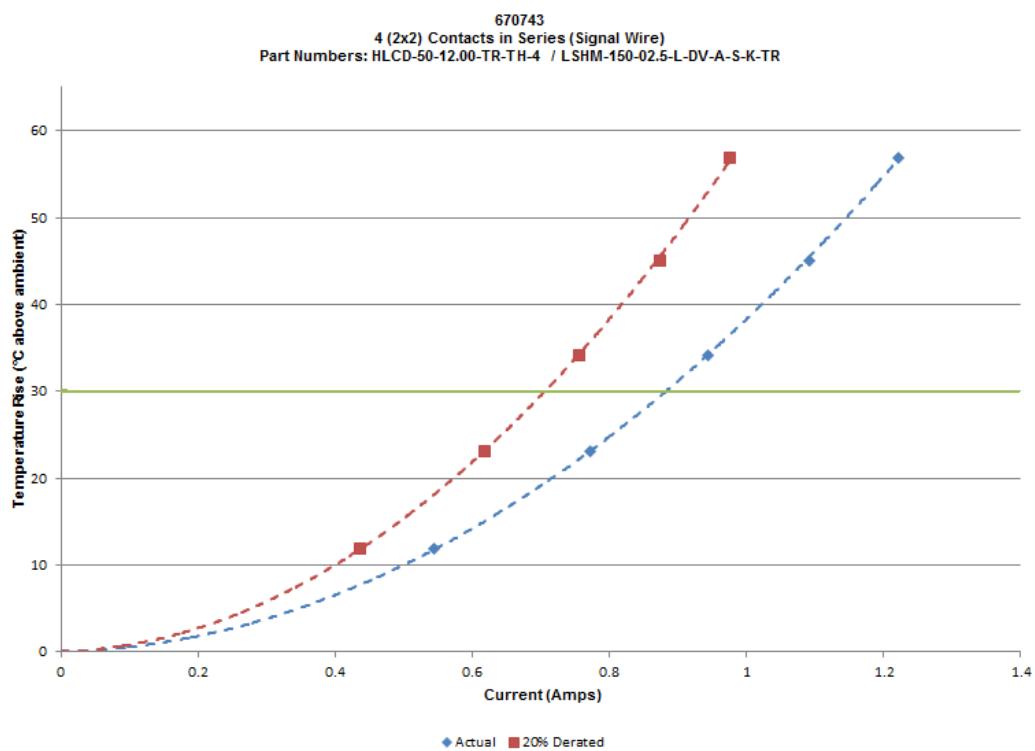
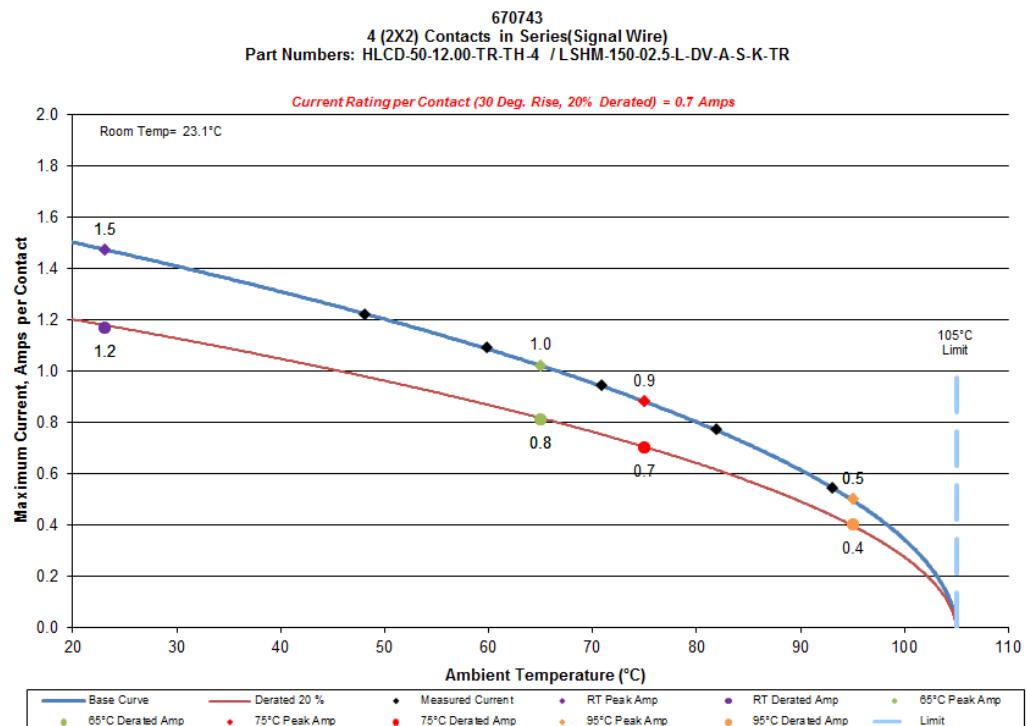
- 1) High quality thermocouples whose temperature slopes track one another were used for temperature monitoring.
- 2) The thermocouples were placed at a location to sense the maximum temperature generated during testing.
- 3) Temperature readings recorded are those for which three successive readings, 15 minutes apart, differ less than 1° C (computer controlled data acquisition).
- 4) Adjacent contacts were powered:
 - a. Linear configuration with 2 adjacent conductors/contacts powered



DATA SUMMARIES Continued

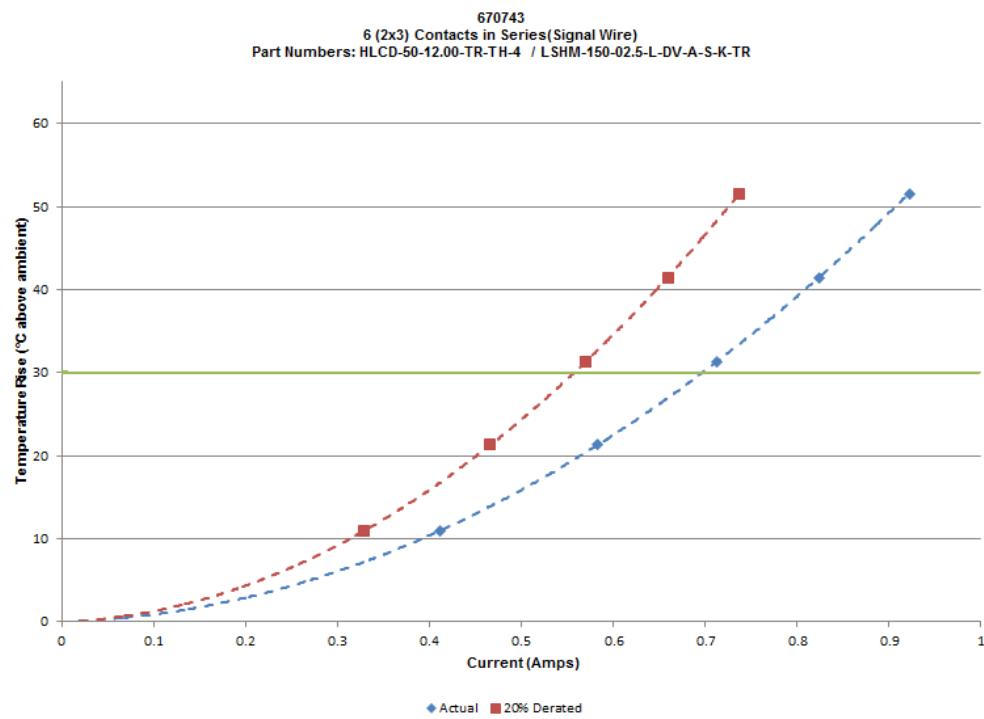
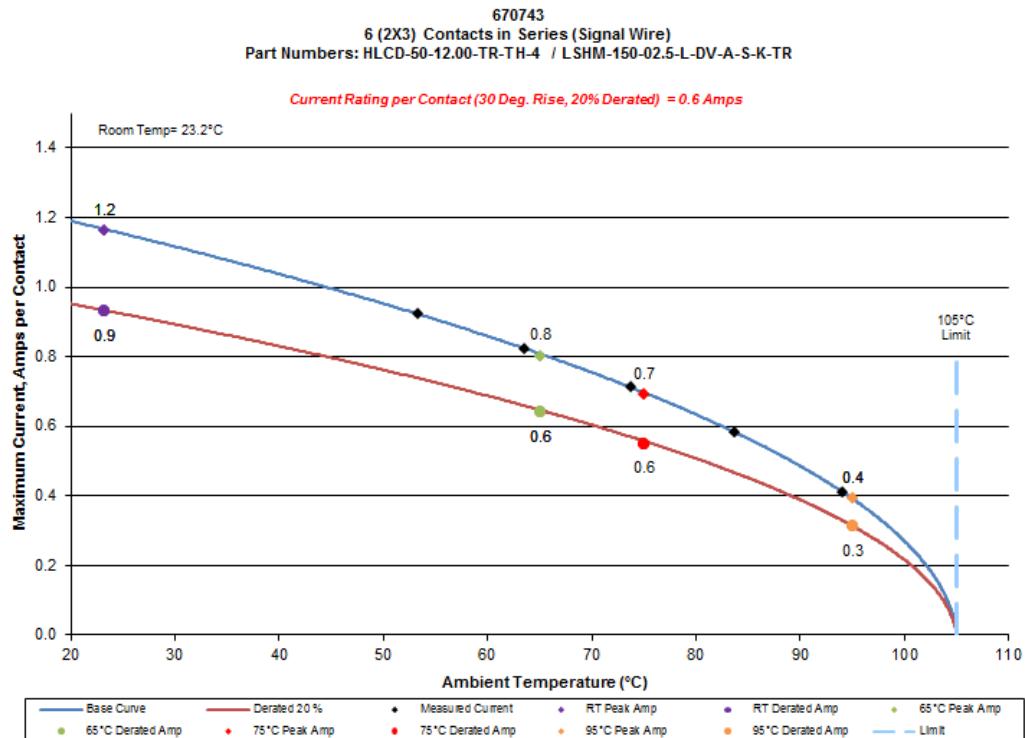
DATA SUMMARIES Continued

b. Linear configuration with 4 adjacent conductors/contacts powered



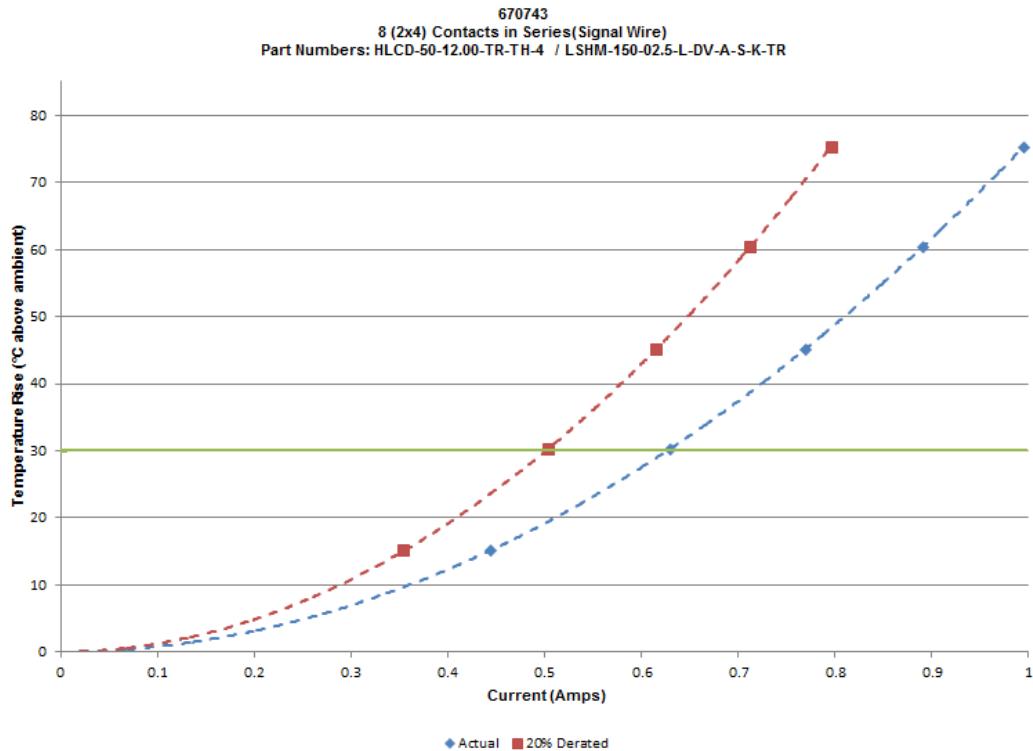
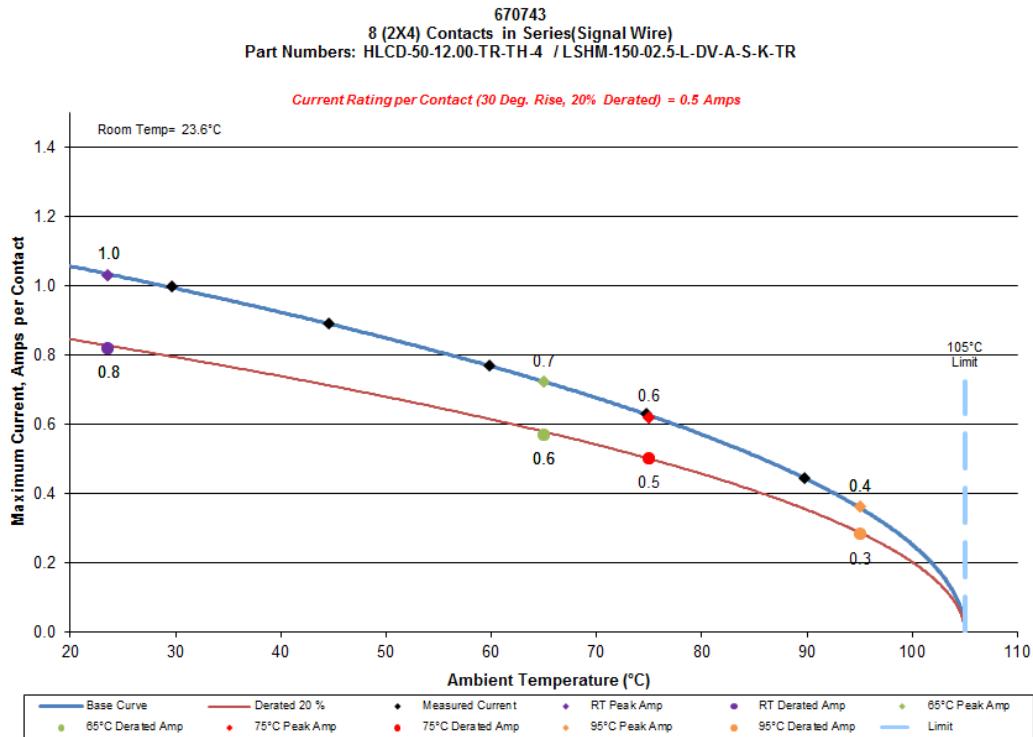
DATA SUMMARIES Continued

c. Linear configuration with 6 adjacent conductors/contacts powered



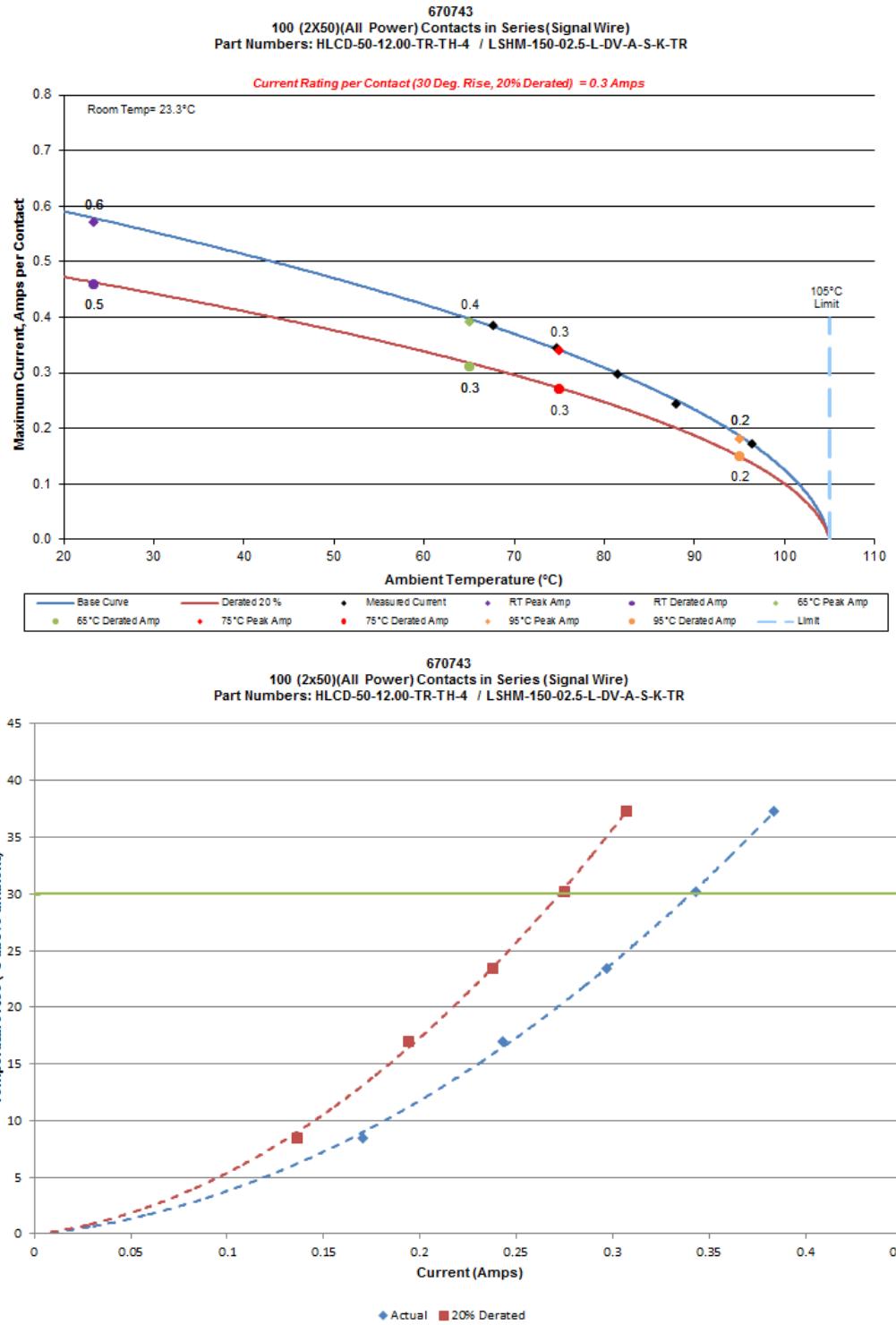
DATA SUMMARIES Continued

d. Linear configuration with 8 adjacent conductors/contacts powered



DATA SUMMARIES Continued

e. Linear configuration with All adjacent conductors/contacts powered



DATA SUMMARIES Continued

LLCR Shock & Vibration: HLCD-50-24.00-TRS-TRS-2/LSHM-150-02.5-L-DV-A-S-K-TR

- 1). A total of 192 points were measured.
- 2). EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets*.
- 3). The following guidelines are used to categorize the changes in LLCR as a result from stressing.
 - a. $\leq +5.0$ mOhms: ----- Stable
 - b. $+5.1$ to $+10.0$ mOhms: ----- Minor
 - c. $+10.1$ to $+15.0$ mOhms: ----- Acceptable
 - d. $+15.1$ to $+50.0$ mOhms: ----- Marginal
 - e. $+50.1$ to $+2000$ mOhms ----- Unstable
 - f. $>+2000$ mOhms: ----- Open Failure

		LLCR Measurement Summaries by Pin Type				
Date	9/2/2016	9/9/2016				
	23	23				
Room Temp (Deg C)	43	49				
Rel Humidity (%)						
Technician	Aaron McKim	Aaron McKim				
mOhm values	Actual Initial	Delta Shock-Vib	Delta	Delta		
Pin Type 1: Signal						
Average	764.16	0.88				
St. Dev.	9.62	0.99				
Min	746.10	0.01				
Max	782.75	6.99				
Summary Count	192	192				
Total Count	192	192				

LLCR Delta Count by Category						
mOhms	Stable	Minor	Acceptable	Marginal	Unstable	Open
	≤ 5	$>5 \text{ & } \leq 10$	$>10 \text{ & } \leq 15$	$>15 \text{ & } \leq 50$	$>50 \text{ & } \leq 1000$	>1000
Shock-Vib	191	1	0	0	0	0

Nanosecond Event Detection:

Shock and Vibration Event Detection Summary	
Contacts tested	60
Test Condition	C, 100g's, 6ms, Half-Sine
Shock Events	0
Test Condition	V-B, 7.56 rms g
Vibration Events	0
Total Events	0

DATA SUMMARIES Continued**CABLE PULL FORCE****0° Pull**

		Force (lbs)
Minimum		9.50
Maximum		12.0
Average		10.7

90° Pull

		Force (lbs)
Minimum		0.92
Maximum		1.33
Average		1.10

INSULATION RESISTANCE (IR):

	Pin to Pin		
	Mated	Unmated	Unmated
	Minimum	HLCD/LSHM	HLCD
Initial	45000	Not Tested	Not Tested
Thermal	45000	Not Tested	Not Tested
Humidity	45000	Not Tested	Not Tested

	Pin to Ground		
	Mated	Unmated	Unmated
	Minimum	HLCD/LSHM	HLCD
Initial	45000	Not Tested	Not Tested
Thermal	45000	Not Tested	Not Tested
Humidity	45000	Not Tested	Not Tested

DATA SUMMARIES Continued**DIELECTRIC WITHSTANDING VOLTAGE (DWV):**

Voltage Rating Summary	
Minimum	HLCD/LSHM
Break Down Voltage	524
Test Voltage	395
Working Voltage	130

Pin to Pin	
Initial Test Voltage	Passed
After Thermal Test Voltage	Passed
After Humidity Test Voltage	Passed

Pin to Ground	
Initial Test Voltage	Passed
After Thermal Test Voltage	Passed
After Humidity Test Voltage	Passed

DATA SUMMARIES Continued**CABLE FLEX****INSULATION RESISTANCE (IR)**

Pin to Pin	
Mated	
Minimum	
Initial	37000
After 500 Flex Cycles	45000

Pin to Ground	
Mated	
Minimum	
Initial	45000
After 500 Flex Cycles	45000

DIELECTRIC WITHSTANDING VOLTAGE (DWV):

Voltage Rating Summary	
Minimum	
Break Down Voltage	524
Test Voltage	395
Working Voltage	130

Pin to Pin	
Initial Test Voltage	Passed
After 500 Flex Cycles Test Voltage	Passed

Pin to Ground	
Initial Test Voltage	Passed
After 500 Flex Cycles Test Voltage	Passed

EQUIPMENT AND CALIBRATION SCHEDULES

Equipment #: THC-02

Description: Temperature/Humidity Chamber

Manufacturer: Thermotron

Model: SE-1000-6-6

Serial #: 31808

Accuracy: See Manual

... Last Cal: 02/16/2015, Next Cal: 02/16/2016

Equipment #: HPM-01

Description: Hipot Megommeter

Manufacturer: Hipotronics

Model: H306B-A

Serial #: M9905004

Accuracy: 2 % Full Scale Accuracy

... Last Cal: 05/24/2015, Next Cal: 08/24/2016

Equipment #: TSC-01

Description: Vertical Thermal Shock Chamber

Manufacturer: Cincinnati Sub Zero

Model: VTS-3-6-6-SC/AC

Serial #: 10-VT14993

Accuracy: See Manual

... Last Cal: 05/18/2015, Next Cal: 05/18/2016

Equipment #: TCT-01

Description: Test Stand

Manufacturer: Chatillon

Model: TCD-1000

Serial #: 05 23 00 02

Accuracy: Speed Accuracy: +/-5% of max speed; Displacement: +/- .5% or +/- .005, whichever is greater.

... Last Cal: 08/24/2015, Next Cal: 08/24/2016

Equipment #: MO-04

Description: Multimeter /Data Acquisition System

Manufacturer: Keithley

Model: 2700

Serial #: 0798688

Accuracy: See Manual

... Last Cal: 04/30/2015, Next Cal: 04/30/2016

Equipment #: PS-01

Description: Power Supply

Manufacturer: Agilent

Model: AT-6032A

Serial #: MY41001186

Accuracy: Last Cal: 06/12/2015, Next Cal: 06/12/2016

EQUIPMENT AND CALIBRATION SCHEDULES

Equipment #: MO-11

Description: Switch/Multimeter

Manufacturer: Keithley

Model: 3706

Serial #: 120169

Accuracy: See Manual

... Last Cal: 09/11/2015, Next Cal: 09/11/2016

Equipment #: SVC-01

Description: Shock & Vibration Table

Manufacturer: Data Physics

Model: LE-DSA-10-20K

Serial #: 10037

Accuracy: See Manual

... Last Cal: 04/22/2016, Next Cal: 04/22/2017

Equipment #: ACLM-01

Description: Accelerometer

Manufacturer: PCB Piezotronics

Model: 352C03

Serial #: 115819

Accuracy: See Manual

... Last Cal: 07/18/2016, Next Cal: 07/18/2017

Equipment #: ED-03

Description: Event Detector

Manufacturer: Analysis Tech

Model: 32EHD

Serial #: 1100604

Accuracy: See Manual

... Last Cal: 10/31/2015, Next Cal: 10/31/2016